

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5466355

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUMIAO WU	03/20/2019
LEFENG LIU	03/20/2019
QIUJIE LIN	03/20/2019
XINSHUI HUANG	03/20/2019
YOUJUN XIONG	03/20/2019
RECEIVING PARTY DATA	
Name:	UBTECH ROBOTICS CORP
Street Address:	16TH AND 22ND FLOORS, BLOCK C1, NANSHAN I PARK, NO. 1001 XUEYUAN ROAD, NANSHAN DISTRICT, SHENZHEN, GUANGDONG
City:	SHENZHEN
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29687006
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	909-284-1648
Email:	54968925@qq.com,ivy.yang@bohui-ip.com,pair@jumpy-ip.com
Correspondent Name:	CHEW PATENTS GROUP (BOHUI)
Address Line 1:	28039 SCOTT RD
Address Line 2:	SUITE D-180
Address Line 4:	MURRIETA, CALIFORNIA 92563
ATTORNEY DOCKET NUMBER:	2019UBH-A2US001
NAME OF SUBMITTER:	RAYMOND J. CHEW
SIGNATURE:	/Raymond J. Chew//
DATE SIGNED:	04/09/2019
Total Attachments: 2	
source=2019UBH-A2US001_ASM#page1.tif	

ASSIGNMENT

WHEREAS Yumiao Wu; Lefeng Liu; Qijie Lin; Xinsui Huang; Youjun Xiong, the assignors, whose mailing address is/are 16th and 22nd Floor, Block C1, Nanshan I Park, No. 1001 Xueyuan Road, Nanshan District, Shenzhen, Guangdong, China,

have invented certain new and useful improvements in an invention relating to and entitled CONSTRUCTION SET BLOCK, the invention, as fully set forth and described in an application for Letters Patent to be filed at the United States Patent and Trademark Office and naming the assignors as inventors and applicants;

AND WHEREAS UBTECH Robotics Corp. of China, the assignee, whose mailing address is 16th and 22nd Floor, Block C1, Nanshan I Park, No. 1001 Xueyuan Road, Nanshan District, Shenzhen, Guangdong, China,

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to Any Letters Patent that may be obtained therefor;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, receipt of which is hereby acknowledged, the assignors, do hereby confirm that they have sold, assigned and transferred, and do hereby sell, assign and transfer to the assignee the full and exclusive right to the said invention in the United States and their entire right, title and interest for the United States in and to the invention, together with their entire right, title and interest in and to said application, any and all divisional applications thereof, and any and all Letters Patent of the United States which may issue or be reissued for the invention;

AND the assignors hereby authorize and request the Director of the United States Patent and Trademark Office to issue to said assignee of any and all said Letters Patent not already issued as the assignee of their entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by the assignors had this assignment and sale not been made.

AND the assignors, on behalf of themselves and their executors and administrators, hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent of the United States for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

page 1 of 2

Cont.: Assignment

Yumiao Wu [Signature of Inventor], SIGNED on this [20th] day of [March], 2019

Yumiao Wu

Lefeng Liu [Signature of Inventor], SIGNED on this [20th] day of [March], 2019

Lefeng Liu

Qinjie Lin [Signature of Inventor], SIGNED on this [20th] day of [March], 2019

Qinjie Lin

Xinshui Huang [Signature of Inventor], SIGNED on this [20th] day of [March], 2019

Xinshui Huang

Youjun Xiong [Signature of Inventor], SIGNED on this [20th] day of [March], 2019

Youjun Xiong

page 2 of 2